REMARKS

Claims 28-39 are currently pending. Claim 34 is amended herein. Reconsideration and allowance of the remaining Claims are respectfully requested.

102 Rejections

Claims 34-39 are rejected under 35 U.S.C. § 103(a) as being anticipated by Evans et al. (U.S. Patent No. 5,897,424) in view of Yu (U.S. Patent No. 5435772). Applicants have reviewed the cited references and respectfully submit that the present invention as is recited in Claims 34-39 are neither anticipated nor rendered obvious by Evans et al. (U.S. Patent No. 5,897,424) in view of Yu (U.S. Patent No. 5435772).

The Examiner is respectfully directed to independent Claim 34 which recites that an embodiment of the present invention is directed to a polishing apparatus comprising:

> ...a carrier overlying the polishing pad, wherein the polishing platen is further characterized as having a tapered region, and wherein at least a portion of said second front surface of said peripheral region of the polishing pad overlies the tapered region.

Claims 35-39 depend from independent Claim 34 and recite further features of the claimed invention.

Evans et al. does not anticipate or render obvious a polishing apparatus that includes a polishing platen, a polishing pad overlying the polishing platen and a carrier overlying the polishing pad and wherein the polishing platen is characterized by "a tapered region, and wherein at least a portion of said second front surface of said peripheral region of the polishing pad overlies the tapered region." Evans only shows a renewable polishing lap. Nowhere in the Evans et al. reference is there shown or suggested a polishing apparatus that includes both a carrier overlying a polishing pad and a polishing platen that has a tapered

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region that is overlain by at least a portion of said second front surface of a peripheral region

of a polishing pad as is recited in Claim 34. Consequently the Applicants' invention as set

forth in Claims 34-39 are neither anticipated nor rendered obvious by Evans.

Yu does does not remedy the deficiencies of Evans et al. noted above. More

specifically. Yu does not anticipate or render obvious a polishing apparatus that includes a

polishing platen, a polishing pad overlying the polishing platen and a carrier overlying the

polishing pad wherein the polishing platen is characterized by "a tapered region, and wherein

the at least a portion of said second front surface of said peripheral region of the polishing

pad overlies the tapered region." Yu only shows a method of polishing a semiconductor

substrate.

It is important to note that Yu does disclose a platen 14 (see column 3 in several

locations) but the platen that is disclosed does not include a tapered portion. In fact, nowhere

in the Yu reference is there shown or suggested a polishing apparatus that includes both: (1) a

carrier overlying a polishing pad and (2) a polishing platen that has a tapered region that is

overlain by at least a portion of a second front surface of a peripheral region of a polishing

pad as is recited in Claim 34.

Nowhere in the Yu et al. reference is there shown or suggested a polishing apparatus

that includes both a carrier overlying a polishing pad and a polishing platen that has a tapered

region that is overlain by at least a portion of said second front surface of a peripheral region

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of a polishing pad as is recited in Claim 34. Consequently the Applicants' invention as set

forth in Claims 34-39 are neither anticipated nor rendered obvious by Yu et al.

Therefore, Applicants respectfully submit that Yu et al. does not anticipate or render

obvious the present Claimed invention as is recited in independent Claim 34 and as such

Claim 34 overcomes the Examiners basis for rejection under 35 U.S.C. 103(a). Accordingly,

Applicants submit that Claim 34 is in condition for allowance. In addition, Yu et al. does not

anticipate or render obvious the present invention as is recited in Claims 35-39 which

depends from independent Claim 34, and that Claims 35-39 are in condition for allowance as

being dependent on an allowable base claim.

Conclusion

In light of the above-listed amendments and remarks, Applicants respectfully request

allowance of the remaining Claims.

The Examiner is urged to contact Applicants' undersigned representative if the

Examiner believes such action would expedite resolution of the present Application.

Respectfully submitted,

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Dated: $3/\ell$, 2005

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